深圳市一众显示科技有限公司

SHEN ZHEN TEAM SOURCE DISPLAY TECH. CO, LTD.

TFT-LCD Module Specification

Module NO.： TST24003T-00-P

Version： V1.0

☐ APPROVAL FOR SPECIFICATION ☐ APPROVAL FOR SAMPLE

For Customer’ s Acceptance：	
Approved by	Comment

Team Source Display：		
Presented by	Reviewed by	Organized by

Version No.	Date	Content	Remark
V1.0	2013-03-04	Initial Release	

Contents

1. SPECIFICATIONS

1.1 Features

Main LCD panel

Item	Standard Value
Display Type	240*(R、G、B)*320 Dots
LCD Type	a-si TFT，Positive，Transmissive type
Screen size(inch)	2.4” (Diagonal)
Viewing Direction	12 O’clock
Color configuration	R.G.B. vertical stripe
Backlight Type	White LED B/L
Interface	8080 8Bit / 16Bit data bus
Other(controller/driver IC)	ILI9341

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	42.72 (W) *60.26 (L) *2.3 (H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	36.72（W）*49.00（L）	mm

Note : For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit
System Power Supply Voltage	VCI	-	-0.3	+4.6	V
	VGH-VSS	-	-0.3	+18.5	V
	VSS-VGL	-	-0.3	+18.5	V
Input Voltage	V_{IN}	-	-0.3	VCI+0.3	V
Operating Temperature	T_{OP}	-	-20	+70	°C
Storage Temperature	T_{ST}	-	-30	+80	°C
Storage Humidity	H_D	Ta < 40°C	20	90	%RH

1.4 DC Electrical Characteristics

Module VSS= 0V, Ta = 25°C

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Power Supply Voltage	VCI	-	2.6	2.8	3.3	V
Input High Voltage	V_{IH}	-	0.8*VCI	-	VCI	V
Input Low Voltage	V_{IL}	-	-0.3	-	0.2*VCI	V
Output High Voltage	V_{OH}	-	0.8*VCI	-	-	V
Output Low Voltage	V_{OL}	-	-	-	0.2*VCI	V
Supply Current	ICC	VCI =2.8 V Pattern=full display*1	-	TBD	-	mA

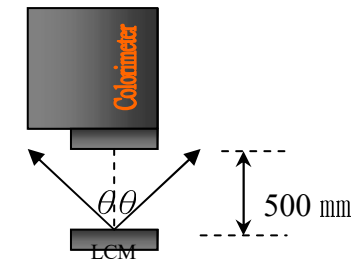
Note1:Maximum current display

1.5 Optical Characteristics

TFT LCD panel VCC=2.8V, Ta=25°C

Item		Symbol	Condition	Min.	Typ.	Max.	unit	
Response time		Tr+Tf	Ta = 25°C θX, θY = 0°	-	30	-	ms	Note2
Contrast ratio		CR	Ta = 25°C θX , θY = 0°		250	-	-	Note3
Color of CIE Coordinate （With B/L）	White	X		0.283	0.303	0.323	-	Note1
		Y		0.305	0.325	0.345		
	Red	X		0.606	0.626	0.646		
		Y		0.314	0.334	0.354		
	Green	X		0.257	0.277	0.297		
		Y		0.529	0.549	0.569		
	Blue	X		0.122	0.142	0.162		
		Y		0.102	0.122	0.142		
Average Brightness Pattern=white display （main）		IV	IF= 60mA	-	150	-	cd/m^2	Note1
Uniformity		△B	IF= 60mA	80	-	-	%	Note1

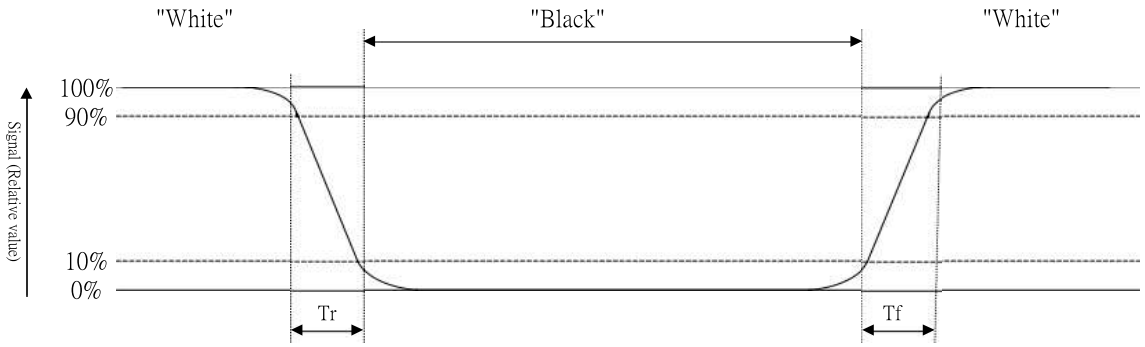
Note1:
1：△B=B(min) / B(max) ×100%
2：Measurement Condition for Optical Characteristics:
a：Environment: 25℃±5℃ / 60±20%R.H，no wind，dark room below 10 Lux at typical lamp current and typical operating frequency.
b：Measurement Distance: 500 ± 50 ㎜ ，(θ= 0°)
c：Equipment: TOPCON BM-7 fast，(field 1°)，after 10 minutes operation.
d：The uncertainty of the C.I.E coordinate measurement ±0.01，Average Brightness ± 4%



Colorimeter=BM-7 fast

Note2: Definition of response time:
The output signals of photo detector are measured when the input signals are changed from “black” to “white”(falling time) and from “white” to “black”(rising time),

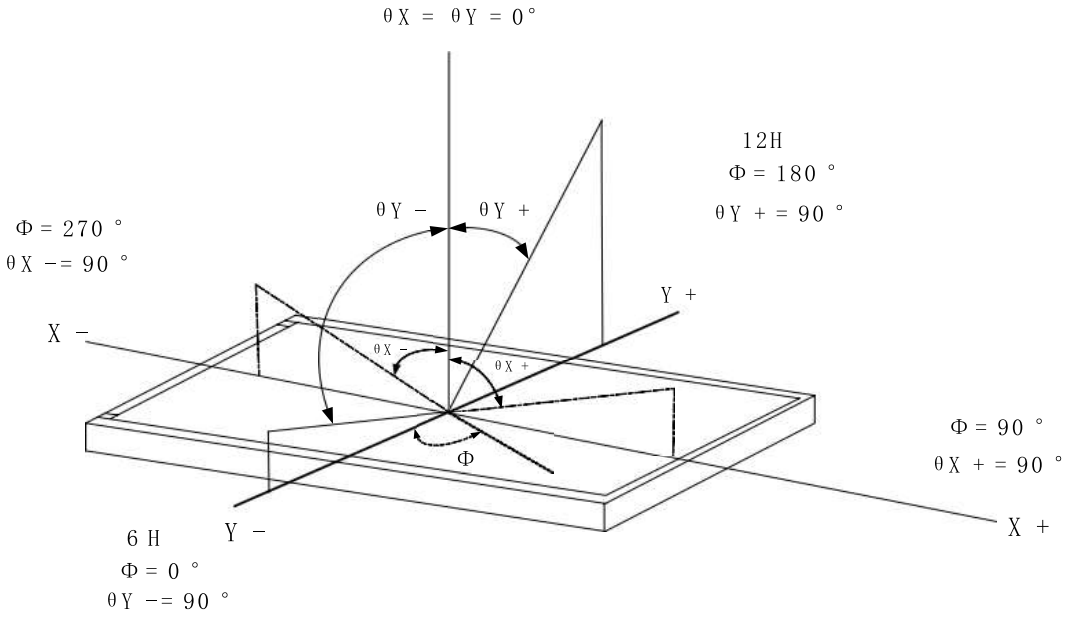
respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.
Refer to figure as below:



Note3: Definition of contrast ratio:
Contrast ratio is calculated with the following formula

$$\text{Contrast ratio (CR)} = \frac{\text{Photo detector output when LCD is at “White” state}}{\text{Photo detector output when LCD is at “Black” state}}$$

Note4: Definition of viewing angle:
Refer to figure as below:



1.6 Backlight & LED Characteristics

LCD Module with LED Backlight

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°C	-	60	mA
Forward Voltage	VF	Ta =25°C	-	3.5	V
Power Dissipation	PD	Ta =25°C	-	210	mW

Electrical / Optical Characteristics

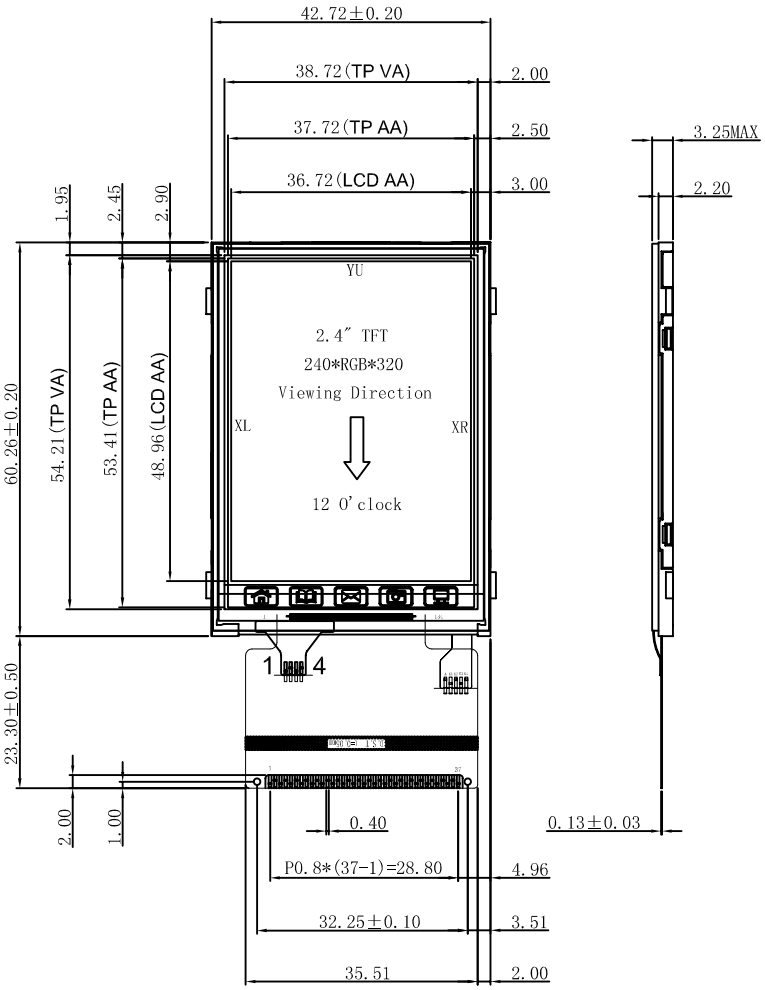
Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	IF=60mA VF=3.2 V 4 white leds Ta =25°C	2.8	3.2	3.5	V
Average Brightness (Without LCD)	IV		3500	-	-	cd/m^2
Color of CIE Coordinate (without LCD)	X		0.26	-	0.31	-
	Y		0.26	-	0.31	
Color	White					

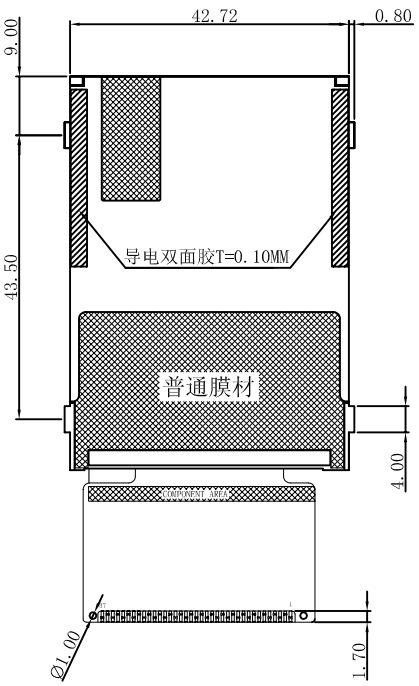
2. MODULE STRUCTURE

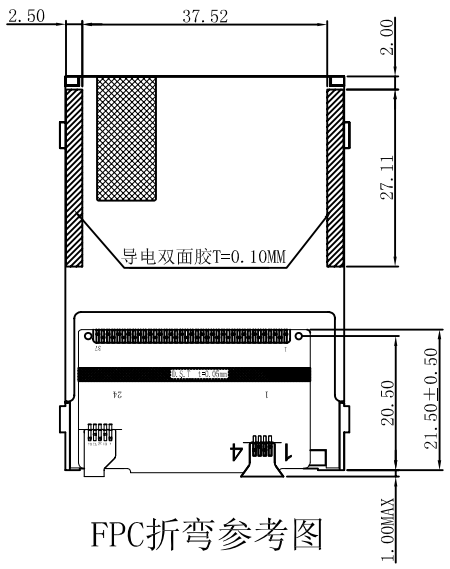
2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

REV	DESCRIPTION:	DATE
V00	First issue	2012-12-25







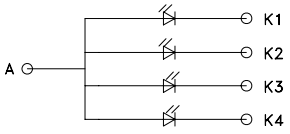
FPC折弯参考图

NO.	SYMBOL
1	DB0
2	DB1
3	DB2
4	DB3
5	GND
6	IOVCC
7	/CS
8	RS
9	/WR
10	/RD
11	IM0
12	X+
13	Y+
14	X-
15	Y-
16	LED-A
17	LED-1
18	LED-2
19	LED-3
20	LED-4
21	FMARK
22	DB4
23	DB8
24	DB9
25	DB10
26	DB11
27	DB12
28	DB13
29	DB14
30	DB15
31	/RESET
32	VCC
33	IOVCC
34	GND
35	DB5
36	DB6
37	DB7

T/P CON

1	2	3	4
YU	XL	YD	XR

NOTES:
1. DISPLAY TYPE: 2.4″ TFT,TRANSMISSIVE
2. DRIVER IC: ILI9341 & Compatible IC
3. VIEWING DIRECTION: 12 O'clock
4. BACKLIGHT: 4 CHIP-WHITE LED
5. BL INPUT CURRENT: 60 mA
6. OPERATING TEMP: -20° C~ +70° C
7. STORAGE TEMP: -30° C~ +80° C
8. GENERAL TOLERANCE: ±0.2
9. The product should measure up with″RoHs″standard



Vf=3.2V(TPYE)
BACKLIGHT CIRCUIT

TEAM SOURCE DISPLAY

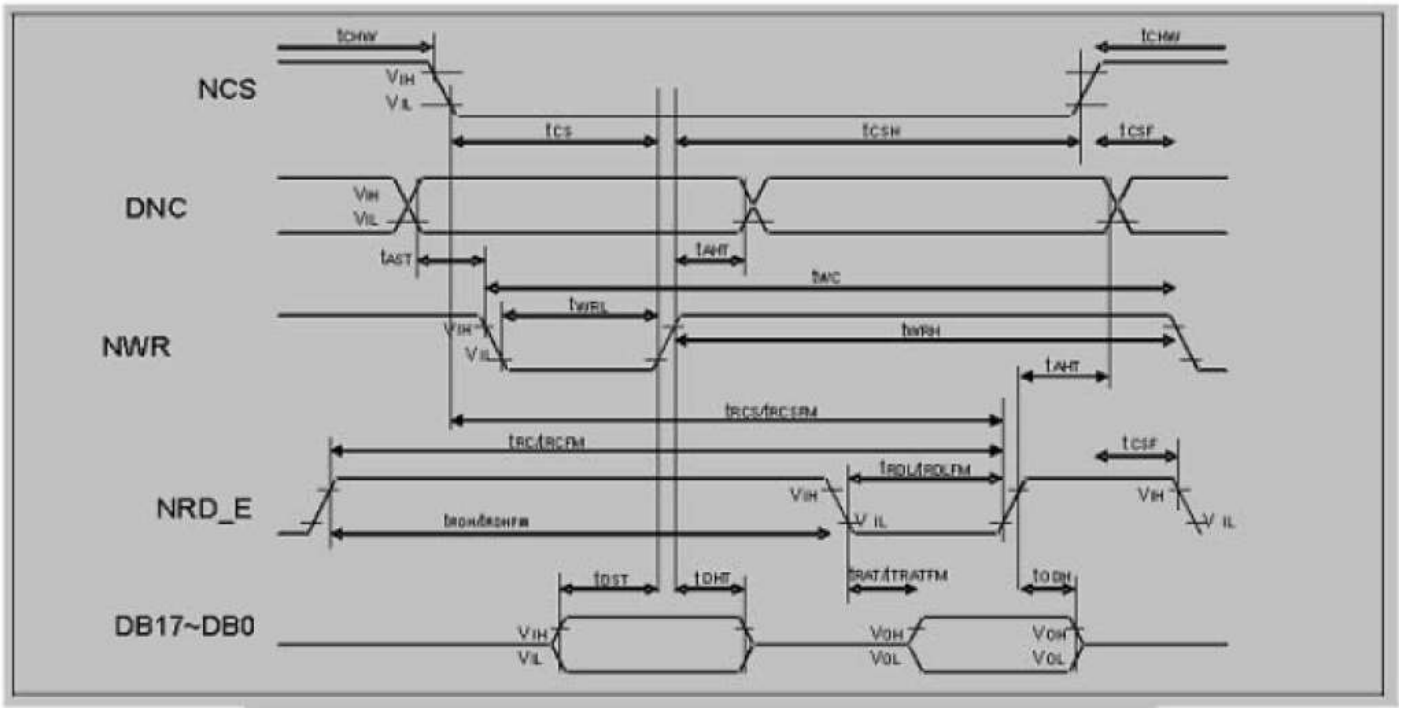
UNIT: MM	SIZE: A4	Scale: 1/1	GENERAL TOLERANCE: ±0.2 Angle=1°	PRJ(3)	
DESIGNED:		DATE:			
CHECKED:			PROJECT NO	TST24003T-00	SHEET:1/1
APPROVED:		DATE:	PART NO.		REV: V00

2.2Interface Pin Description

Refer to the drawing

2.3 Timing Characteristics

2.3.1 Parallel 8080 Timing Characteristics

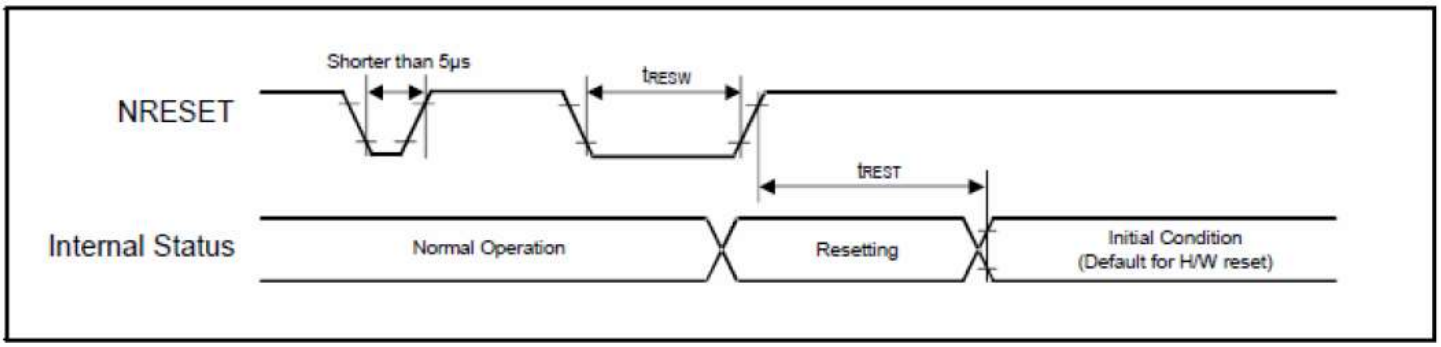


(VSSA=0V, IOVCC=1.65V to 3.6V, VCI=2.5V to 3.6V, Ta = -30 to 70℃)

Signal	Symbol	Parameter	Min.	Max.	Unit	Description
DNC	t_{AST}	Address setup time	0	-	ns	-
	t_{AHT}	Address hold time (Write/Read)	10	-		
NCS	t_{CHW}	Chip select "H" pulse width	0	-	ns	-
	t_{CS}	Chip select setup time (Write)	15	-		
	t_{RCS}	Chip select setup time (Read ID)	45	-		
	t_{RCSFM}	Chip select setup time (Read FM)	355	-		
	t_{CSF}	Chip select wait time (Write/Read)	10	-		
	t_{CSH}	Chip select hold time	10	-		
NWR_RNW	t_{WC}	Write cycle	66	-	ns	-
	t_{WRH}	Control pulse "H" duration	15	-		
	t_{WRL}	Control pulse "L" duration	15	-		
NRD_E (ID)	t_{RC}	Read cycle (ID)	160	-	ns	When read ID data
	t_{RDH}	Control pulse "H" duration (ID)	90	-		
	t_{RDL}	Control pulse "L" duration (ID)	45	-		
NRD_E (FM)	t_{RCFM}	Read cycle (FM)	450	-	ns	When read from frame memory
	t_{RDHFM}	Control pulse "H" duration (FM)	90	-		
	t_{RDLFM}	Control pulse "L" duration (FM)	355	-		
D15 to D0	t_{DST}	Data setup time	10	-	ns	For maximum C_L=30pF For minimum C_L=8pF
	t_{DHT}	Data hold time	10	-		
	t_{RAT}	Read access time (ID)	-	40		
	t_{RATFM}	Read access time (FM)	-	340		
	t_{ODH}	Output disable time	20	80		

Note: The input signal rise time and fall time (tr, tf) is specified at 15 ns or less.
Logic high and low levels are specified as 30% and 70% of IOVCC for Input signals.

2.3.2 Reset Timing Characteristics



Symbol	Parameter	Related Pins	Min.	Typ.	Max.	Note	Unit
tRESW	Reset low pulse width(1)	NRESET	10	-	-	-	µs
tREST	Reset complete time(2)	-	-	-	5	When reset applied during Sleep In mode	ms
		-		-	120	When reset applied during Sleep Out mode	ms

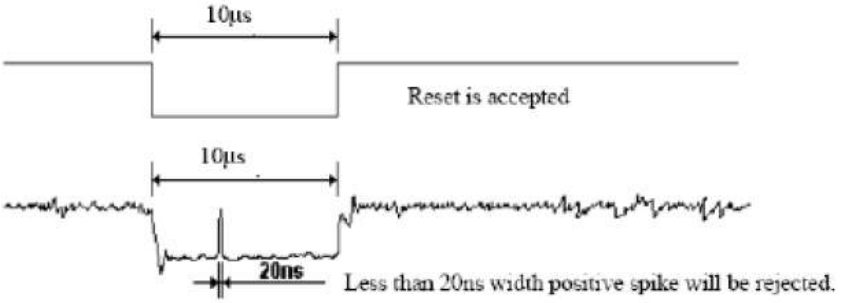
Note: (1) Spike due to an electrostatic discharge on !RES line does not cause irregular system reset according to the following table.

NRESET Pulse	Action
Shorter than 5µs	Reset Rejected
Longer than 10µs	Reset
Between 5µs and 10µs	Reset Start

(2) During the resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep out –mode. The display remains the blank state in Sleep In –mode) and then return to Default condition for H/W reset.

(3) During Reset Complete Time, ID2 and VCOMOF value in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 5ms after a rising edge of RESET.

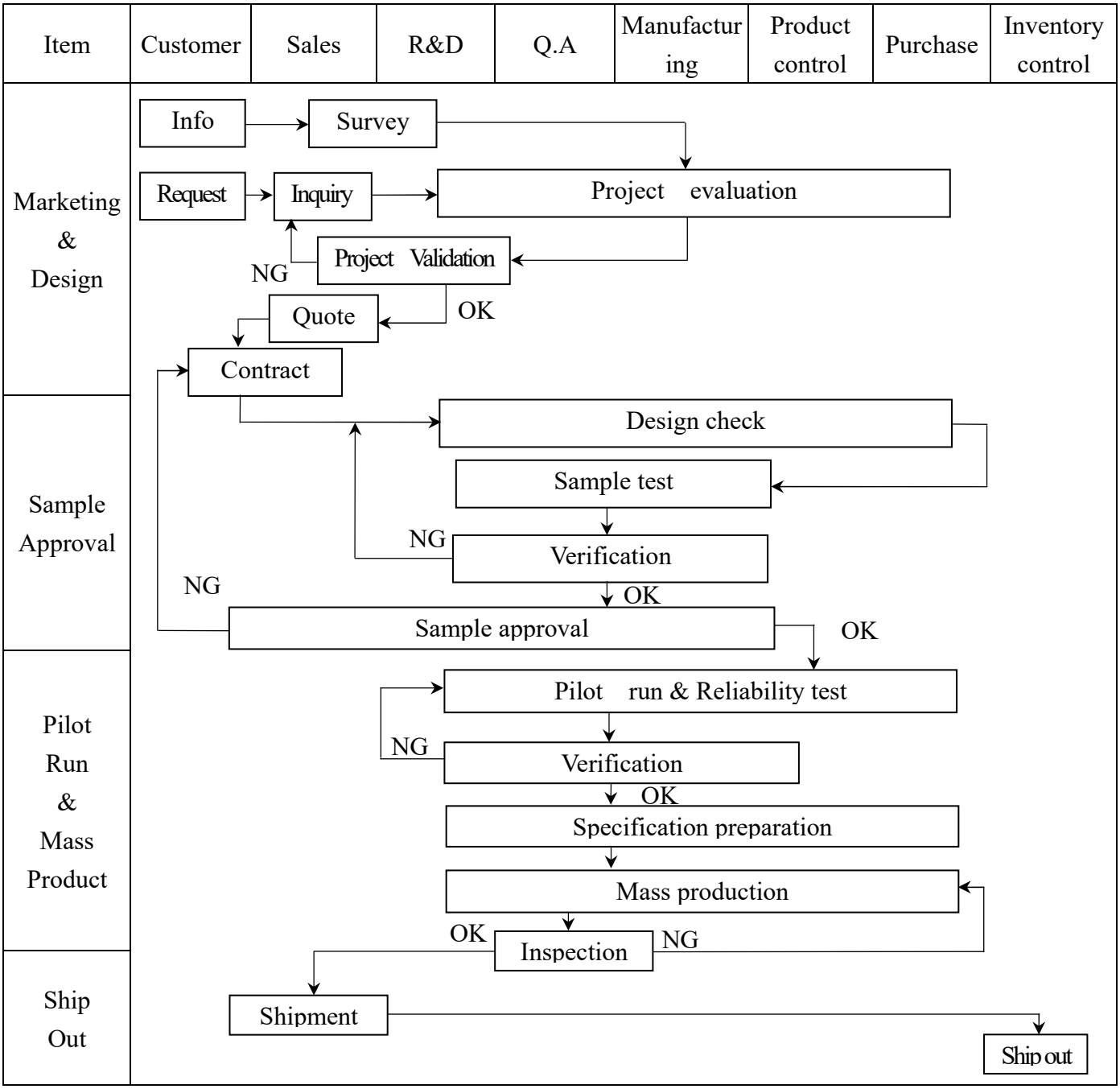
(4) Spike Rejection also applies during a valid reset pulse as shown as below:

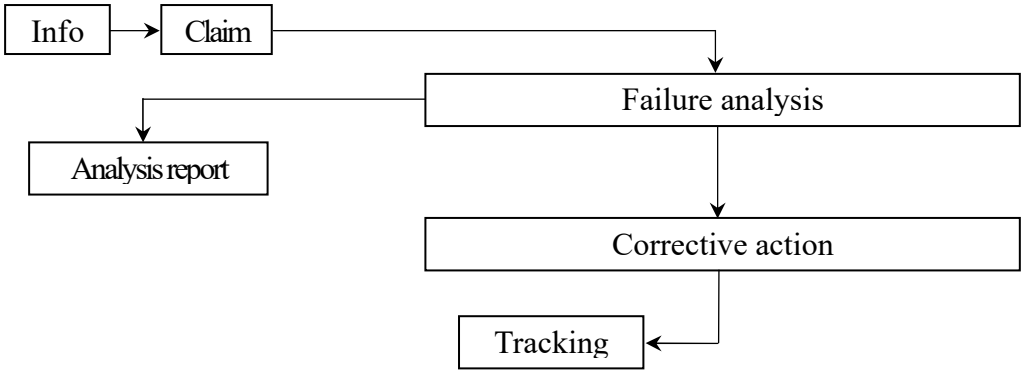


(5) It is necessary to wait 5msec after releasing RESET before sending commands. Also Sleep Out command cannot be sent for 120ms.

3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



Item	Customer	Sales	R&D	Q.A	Manufactu ring	Product control	Purchase	Inventory control
Sales Service								
Q.A Activity	1. Process improvement proposal 2. Equipment calibration 3. Education And Training Activities 4. Standardization Management							

3.2 Inspection Specification

◆Scope ：The document shall be applied to TFT-LCD Module for less than 3.5″ (Ver.02).

◆Inspection Standard：MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.

◆Equipment：Gauge、MIL-STD、Powertip Tester、Sample

◆Defect Level：Major Defect AQL： 0.4 ； Minor Defect AQL： 1.5

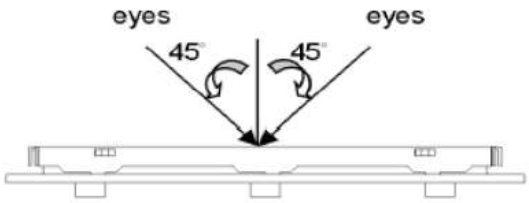
◆OUT Going Defect Level：Sampling.

◆Standard of the product appearance test：

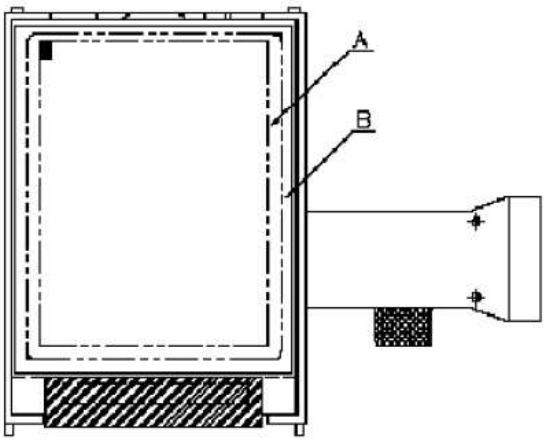
a. Manner of appearance test：

(1). The test best be under 20W×2 fluorescent light，and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A area : viewing area

B area : Outside of viewing area

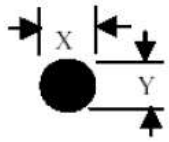
(4). Standard of inspection： (Unit：mm)

◆Specification For TFT-LCD Module Less Than 3.5″ : (Ver.02)

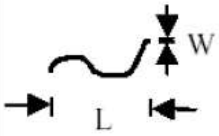
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="3">01</td><td rowspan="3">Product condition</td><td>1.1The part number is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>1.2 Mixed product types.</td><td>Major</td></tr>
<tr><td>1.3 Assembled in inverse direction.</td><td>Major</td></tr>
<tr><td>02</td><td>Quantity</td><td>2.1The quantity is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>03</td><td>Outline dimension</td><td>3.1 Product dimension and structure must conform to structure diagram.</td><td>Major</td></tr>
<tr><td rowspan="5">04</td><td rowspan="5">Electrical Testing</td><td>4.1 Missing line character and icon.</td><td>Major</td></tr>
<tr><td>4.2 No function or no display.</td><td>Major</td></tr>
<tr><td>4.3 Display malfunction.</td><td>Major</td></tr>
<tr><td>4.4 LCD viewing angle defect.</td><td>Major</td></tr>
<tr><td>4.5 Current consumption exceeds product specifications.</td><td>Major</td></tr>
<tr><td>05</td><td>Dot defect
(Bright dot、Dark dot)
On -display</td><td>
<table>
<tr><th colspan="2">Item</th><th>Acceptance (Q'ty)</th></tr>
<tr><td rowspan="4">Dot Defect</td><td>Bright Dot</td><td>≦ 2</td></tr>
<tr><td>Dark Dot</td><td>≦ 3</td></tr>
<tr><td>Joint Dot</td><td>≦ 2</td></tr>
<tr><td>Total</td><td>≦ 3</td></tr>
</table>
5.1 Inspection pattern：full white , full black , Red , Green and blue screens.
5.2 It is defined as dot defect if defect area ＞1/2 dot.
5.3 The distance between two dot defect ≧5 mm.
</td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module Less Than 3.5″ : (Ver.02)

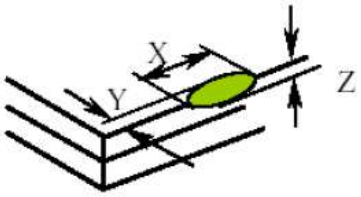
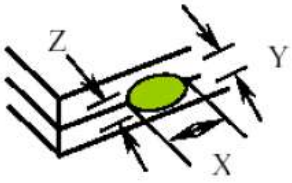
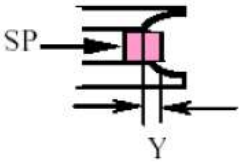
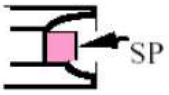
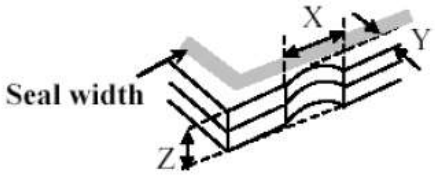
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>06</td><td>Black or white dot、scratch、contamination

Round type
 

Φ=(x+y) / 2

Line type
 
</td><td>6.1 Round type (Non-display or display) :
<table><tr><th>Dimension (diameter : Φ)</th><th>Acceptance (Q'ty)</th></tr><tr><td>Φ ≦ 0.15</td><td>Ignore</td></tr><tr><td>0.15 < Φ ≦ 0.20</td><td>2</td></tr><tr><td>0.20 < Φ ≦ 0.30</td><td>2</td></tr><tr><td>Φ > 0.30</td><td>0</td></tr><tr><td>Total</td><td>3</td></tr></table>
6.2 Line type(Non-display or display) :
<table><tr><th>Length (L)</th><th>Width (W)</th><th>Acceptance (Q'ty)</th></tr><tr><td>---</td><td>W ≦ 0.03</td><td>Ignore</td></tr><tr><td>L ≦5.0</td><td>0.03 < W ≦ 0.05</td><td>3</td></tr><tr><td>---</td><td>W >0.05</td><td>As round type</td></tr><tr><td colspan="2">Total</td><td>3</td></tr></table></td><td>Minor</td></tr>
<tr><td>07</td><td>Polarizer Bubble</td><td><table><tr><th>Dimension (diameter : Φ)</th><th>Acceptance (Q'ty)</th></tr><tr><td>Φ ≦ 0.20</td><td>Ignore</td></tr><tr><td>0.20 < Φ ≦ 0.50</td><td>3</td></tr><tr><td>Φ > 0.50</td><td>0</td></tr><tr><td>Total</td><td>3</td></tr></table></td><td>Minor</td></tr>
</table>

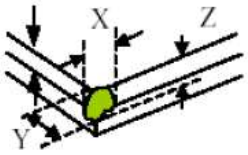
◆Specification For TFT-LCD Module Less Than 3.5″ : (Ver.02)

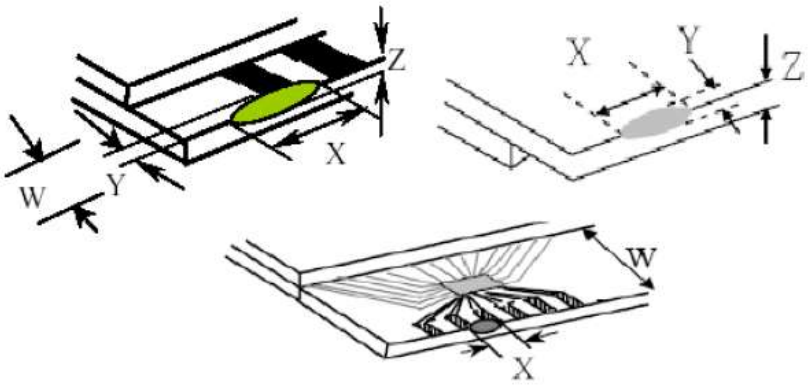
NO	Item	Criterion	Level
08	The crack of glass	Symbols : X : The length of crack　Y : The width of crack. Z : The thickness of crack　W : terminal length t : The thickness of glass　a : LCD side length 8.1 General glass chip : 8.1.1 Chip on panel surface and crack between panels:    【OK】  【NG】  	Minor

X	Y	Z
≦ a	Crack can't enter viewing area	≦1/2 t
≦ a	Crack can't exceed the half of SP width.	1/2 t < Z ≦2 t

◆Specification For TFT-LCD Module Less Than 3.5″ : (Ver.02)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="3">08</td><td rowspan="3">The crack of glass</td><td>
Symbols :

X : The length of crack　　Y : The width of crack.
Z : The thickness of crack　　W : terminal length
t : The thickness of glass　　a : LCD side length
</td><td rowspan="3">Minor</td></tr>
<tr><td>
8.1.2 Corner crack :


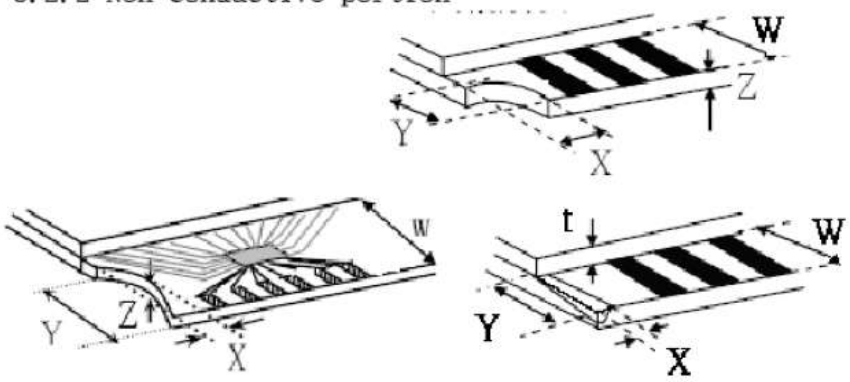
<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦1/5 a</td><td>Crack can't enter viewing area</td><td>Z ≦ 1/2 t</td></tr>
<tr><td>≦1/5 a</td><td>Crack can't exceed the half of SP width.</td><td>1/2 t < Z ≦ 2 t</td></tr>
</table>
</td></tr>
<tr><td>
8.2 Protrusion over terminal :
8.2.1 Chip on electrode pad :


<table>
<tr><th></th><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>Front</td><td>≦ a</td><td>≦ 1/2 W</td><td>≦ t</td></tr>
<tr><td>Back</td><td>≦ a</td><td>≦ W</td><td>≦ 1/2 t</td></tr>
</table>
</td></tr>
</table>

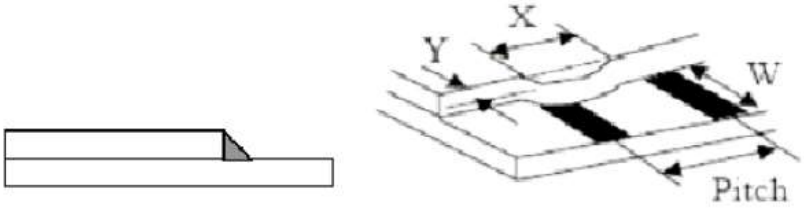
◆Specification For TFT-LCD Module Less Than 3.5″ : (Ver.02)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>08</td><td>The crack of glass</td><td>
Symbols :

X : The length of crack Y : The width of crack.
Z : The thickness of crack W : terminal length
t : The thickness of glass a : LCD side length

8.2.2 Non-conductive portion :


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦ 1/3 a</td><td>≦W</td><td>≦t</td></tr>
</table>
⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.

8.2.3 Glass remain :


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦ a</td><td>≦ 1/3 W</td><td>≦t</td></tr>
</table>
</td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module Less Than 3.5″ : (Ver.02)

NO	Item	Criterion	Level
09	Backlight elements	9.1 Backlight can't work normally.	Major
		9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
10	General appearance	10.1 Pin type、quantity、dimension must match type in structure diagram.	Major
		10.2 No short circuits in components on PCB or FPC .	Major
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≦1.5 mm.	Minor

4.1 Reliability Test Condition

<table>
<tr><th>NO.</th><th>TEST ITEM</th><th colspan="2">TEST CONDITION</th></tr>
<tr><td>1</td><td>High Temperature Storage Test</td><td colspan="2">Keep in +80 ±2℃ 96 hrs
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td>2</td><td>Low Temperature Storage Test</td><td colspan="2">Keep in -30 ±2℃ 96 hrs
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td>3</td><td>High Temperature / High Humidity Storage Test</td><td colspan="2">Keep in +60℃ / 90% R.H duration for 96 hrs
Surrounding temperature, then storage at normal condition 4hrs.
(Excluding the polarizer & T/P)</td></tr>
<tr><td rowspan="2">4</td><td rowspan="2">ESD Test</td><td>Air Discharge:
(include mobile phone)
Apply 2 KV with 5 times
Discharge for each polarity +/-</td><td>Contact Discharge:
(include mobile phone)
Apply 250V with 5 times
discharge for each polarity +/-</td></tr>
<tr><td colspan="2">1. Temperature ambiance:15℃～35℃
2. Humidity relative:30%～60%
3. Energy Storage Capacitance(Cs+Cd):150pF±10%
4. Discharge Resistance(Rd):330Ω±10%
5. Discharge, mode of operation:
Single Discharge (time between successive discharges at least 1 s)
(Tolerance if the output voltage indication: ±5%)</td></tr>
<tr><td>5</td><td>Temperature Cycling Storage Test</td><td colspan="2">-20℃ → +25℃ → +70℃ → +25℃
(30mins) (30mins) (30mins) (30mins)
10 Cycle
Surrounding temperature, then storage at normal condition 4hrs.</td></tr>
<tr><td>6</td><td>Vibration Test (Packaged)</td><td colspan="2">1. Sine wave 10～55 Hz frequency (1 min)
2. The amplitude of vibration :1.5 mm
3. Each direction (X、Y、Z) duration for 2 Hrs</td></tr>
<tr><td>7</td><td>Drop Test (Packaged)</td><td colspan="2">
<table>
<tr><th>Packing Weight (Kg)</th><th>Drop Height (cm)</th></tr>
<tr><td>0 ~ 45.4</td><td>122</td></tr>
<tr><td>45.4 ~ 90.8</td><td>76</td></tr>
<tr><td>90.8 ~ 454</td><td>61</td></tr>
<tr><td>Over 454</td><td>46</td></tr>
</table>
Drop direction :※ 1 corner / 3 edges / 6 sides each 1times</td></tr>
</table>

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

5.2.1 Avoid any strong mechanical shock which can break the glass.
5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
5.2.3 Do not remove the panel or frame from the module.
5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully, do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
5.2.6 Do not touch the display area with bare hands , this will stain the display area.
5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
5.2.8 To control temperature and time of soldering is 320 ± 10°C and 3-5 sec.
5.2.9 To avoid liquid (include organic solvent) stained on LCM

5.3 STORAGE

5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
5.3.2 Do not place the module near organics solvents or corrosive gases.
5.3.3 Do not crush , shake , or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period
The period is within thirteen months since the date of shipping out under normal using and storage conditions.
5.4.2 Unaccepted responsibility
This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

Packing

PARAMETER	Specification	Unit
Outside box	390(L) x 350(W) x 480(H)	mm
Inside pearl wool box	330(L)x185(W)x110(H)	mm
Product quantity of Inside box	64	pcs
Total product quantity	64*8=512	pcs
Total weight	12.5±0.5	Kg